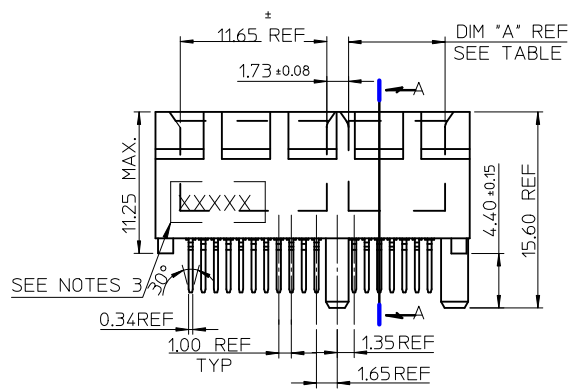
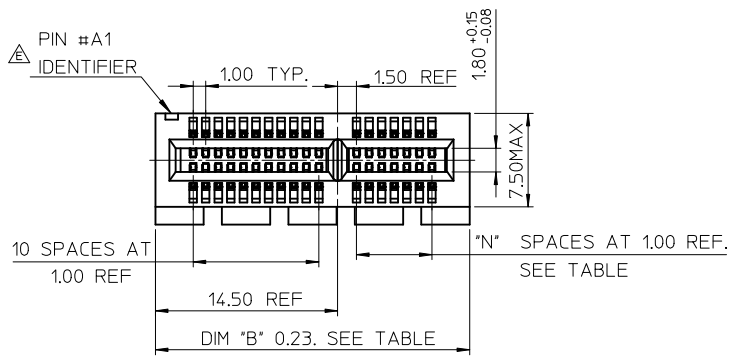
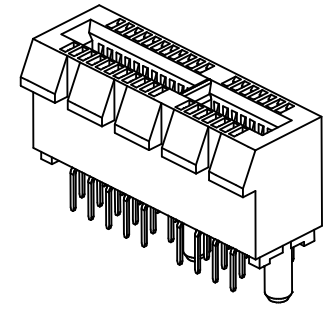
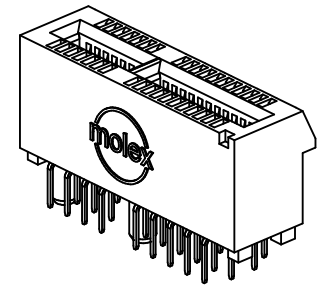
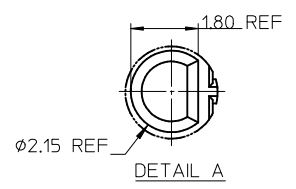


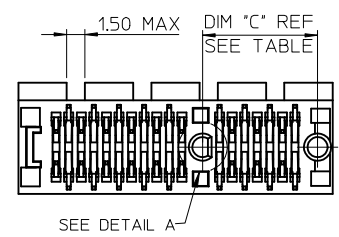
SECTION A-A



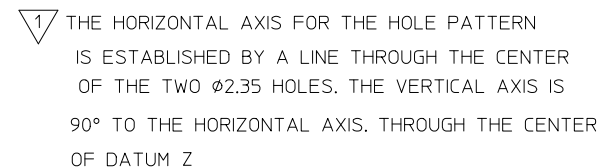
- NOTES:
- 1.MATERIALS:
- 1-1.HOUSING: SEE TABLE ,GLASS FIBER FILLED UL94V-0, COLOR: SEE TABLE.
 - 1-2.CONTACT: SEE TABLE
- 2.PLATING:
- 2-1.CONTACT AREA: GOLD, THICKNESS : SEE TABLE .
 - 2-2.SOLDER TAIL: 100 MICRINCH MIN. TIN PLATING.
 - 2-3.UNDER PLATING: NICKEL PLATING OVERALL.
- 3.WEEK CODE: XX(YEAR) XX(WEEK) X(LOCATION).
- 4.PRODUCT SPECIFICATION REFER TO PS-87715-200.
- 5.PACKAGING SPECIFICATION REFER TO PK-87715-207.
- 6.TEST SUMMARY:REFER TO TS-87715-207.
- 7.LEAD FREE AND ROHS COMPLIANCE PRODUCT.

CONNECTOR LINK WIDTH	# POS REF	N	DIM 'A' REF	DIM 'B' REF	DIM 'C' REF
X1	36	6	7.65	25.00	9.15
X4	64	20	21.65	39.00	23.15
X8	98	37	38.65	56.00	40.15
X16	164	70	71.65	89.00	73.15

PCB THK (REF)	DIM 'D' REF
1.60	2.30
1.58	2.54
2.36	3.00



REVISED EC NO: SH2010-0468 DRWNR:Zhang CHKD:ALLEN LIN APPR:X.J.SONG	DESCRIPTION REV	QUALITY SYMBOLS F=0 F=0 F=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm	INCH	DRAWN BY TOM	DATE 2004/07/20	TITLE PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION) MOLEX INCORPORATED				
		4 PLACES	± ---	± ---	CHECKED BY ALLEN LIN	DATE 2004/07/20					
		3 PLACES	± ---	± ---	APPROVED BY WILSON	DATE 2004/07/20	DOCUMENT NO. SD-87715-207				
		2 PLACES	± 0.25	± ---	MATERIAL NO.						
1 PLACE	± 0.25	± ---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						
		ANGULAR ± 3 °		SEE SHEET 4							



CONNECTOR LINK WIDTH	# POS REF	N	DIM 'A'
X1	36	6	9.15
X4	64	20	23.15
X8	98	37	40.15
X16	164	70	73.15

SEE SHEET 1 EC NO: SH2010-0468 DRAWN:ZHANG 2010/06/15 CHK'D:ALLEN LIN 2010/07/20 APPR:XJSONG 2010/07/02	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
				mm	INCH	DRAWN BY	DATE	TITLE PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION) MOLEX INCORPORATED	
			4 PLACES	± ---	± ---	TOM	2004/07/20		
			3 PLACES	± ---	± ---	CHECKED BY	DATE		
			2 PLACES	± 0.25	± ---	ALLEN LIN	2004/07/20		
			1 PLACE	± 0.25	± ---	APPROVED BY	DATE	MOLEX INCORPORATED	
			ANGULAR ± 3 °		WILSON	2004/07/20	DOCUMENT NO.		SHEET NO.
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE SHEET 4		SD-87715-207		2 OF 4		
SIZE A3			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

10 9 8 7 6 5 4 3 2 1

F

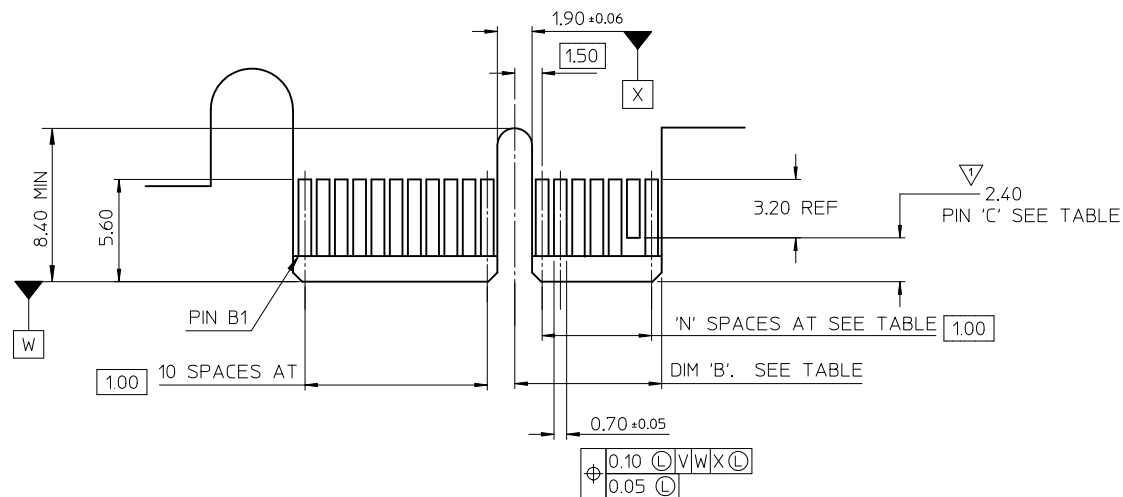
E

D

C

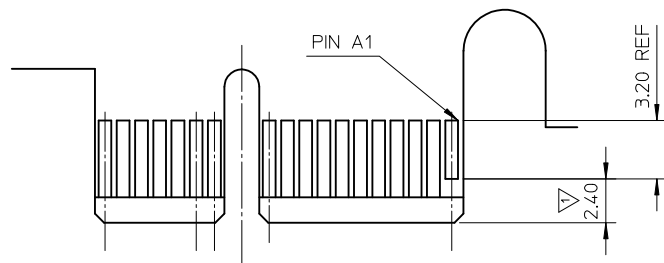
B

A



I/O PANEL DIRECTION

PRIMARY (COMPONENT) SIDE



I/O PANEL DIRECTION

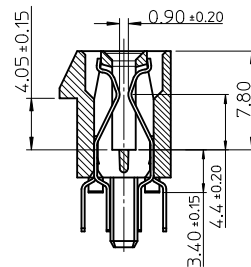
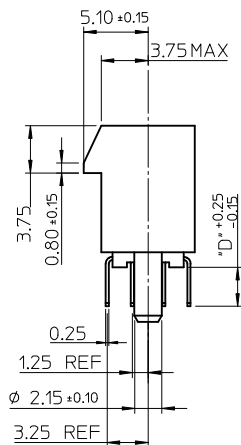
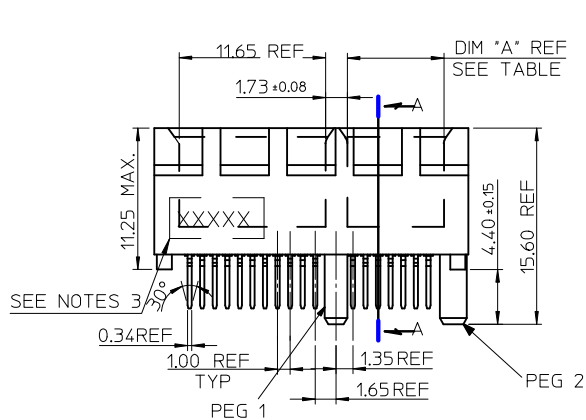
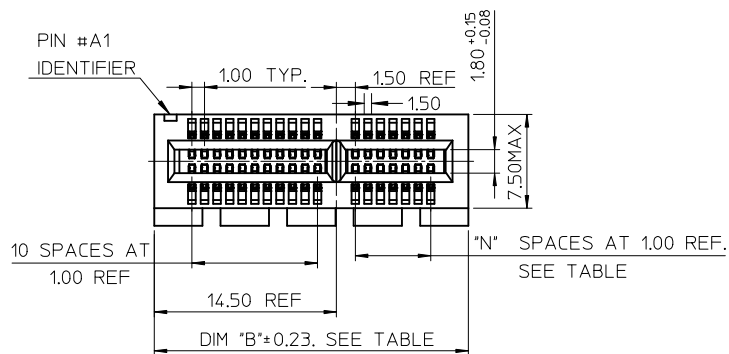
SECONDARY (SOLDER) SIDE

- 1 NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1 AND "C".
- 2 CHAMFER EDGES MUST BE FREE OF CUTTING BURRS.
3. TOLERANCE: .XX±.13

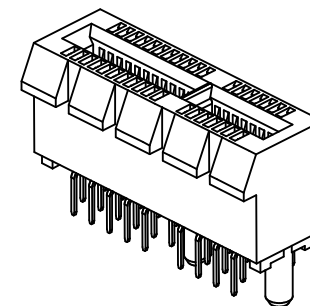
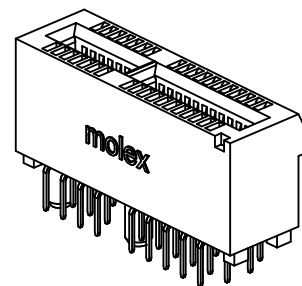
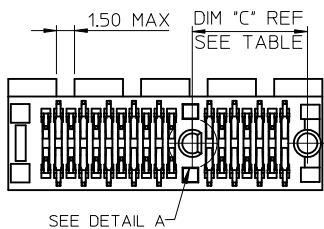
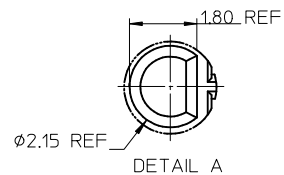
CONNECTOR LINK WIDTH	# POS REF	N	DIM 'B'	'C'
X1	36	6	8.15	B17
X4	64	20	22.15	B17, B31
X8	98	37	39.15	B17, B31 B48
X16	164	70	72.15	B17, B31 B48, B81

SEE SHEET 1 EC NO: SH2010-0468 DRAWN: ZHANG CHKD: ALLEN LIN APPR: XJ SONG REV	DESCRIPTION 2010/06/15 2004/07/20 2010/07/02	QUALITY SYMBOLS =0 =0 =0	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.25 ± --- 1 PLACE ± 0.25 ± --- ANGULAR ± 3 °	DIMENSION STYLE MM ONLY DRAWN BY DATE TOM 2004/07/20 CHECKED BY DATE ALLEN LIN 2004/07/20 APPROVED BY DATE WILSON 2004/07/20 MATERIAL NO. SEE SHEET 4	SCALE TITLE PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION) molex MOLEX INCORPORATED DOCUMENT NO. SD-87715-207	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	SHEET NO. 3 OF 4

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION



SECTION A-A



NOTES:

1.MATERIALS:

1-1.HOUSING: SEE TABLE ,GLASS FIBER FILLED UL94V-0,
COLOR: SEE TABLE.

1-2.CONTACT: SEE TABLE

2.PLATING:

2-1.CONTACT AREA: GOLD, THICKNESS : SEE TABLE .

2-2.SOLDER TAIL: 100 MICROINCH MIN. TIN PLATING.

2-3.UNDER PLATING: NICKEL PLATING OVERALL.

3.DATE CODE: YY MM DD.

4.PRODUCT SPECIFICATION REFER TO PS-87715-200.

5.TEST SUMMARY:REFER TO TS-87715-207.

CONNECTOR LINK WIDTH	# POS REF	N	DIM "A"	DIM "B"	DIM "C"
X1	36	6	7.65	25.00	9.15
X16	164	70	71.65	89.00	73.15

PCB THK (REF)	DIM "D"
1.58	2.54
2.36	3.00

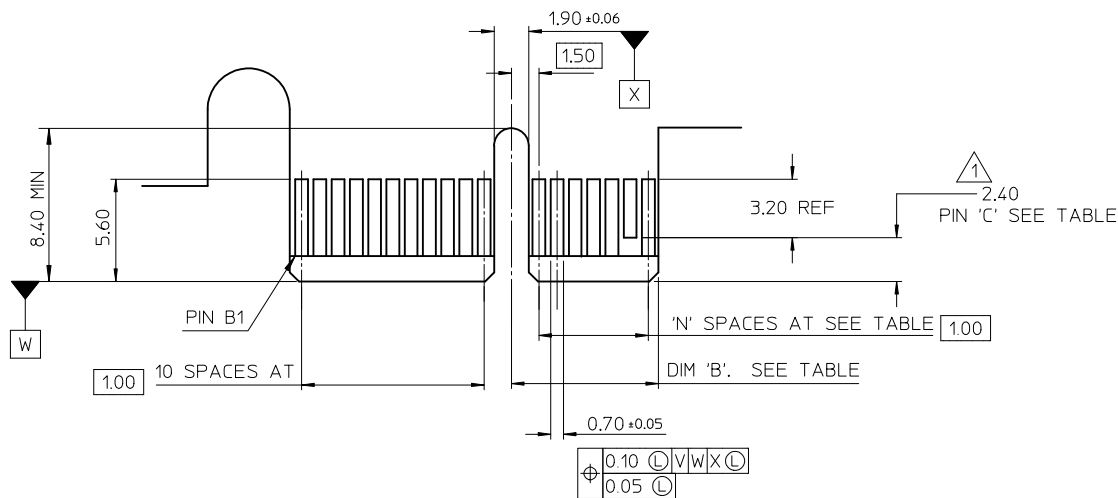
REV	REV	DESCRIPTION
REVISED	EC NO: SH2011-0358	2011/06/02
DRWN:FYANG05	CHKD:	2011/06/02
APPR:RZHANG		

QUALITY SYMBOLS
▽=0
▽=0
▽=0

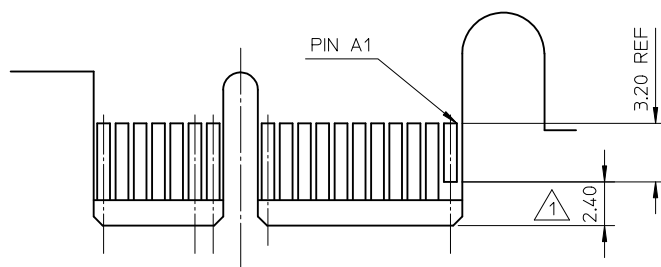
GENERAL TOLERANCES (UNLESS SPECIFIED)		
	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± 0.25	± ---
1 PLACE	± 0.25	± ---
ANGULAR ± 3 °		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		

DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
MM ONLY		METRIC	
DRAWN BY	DATE	TITLE	
DAVID HU	2007/05/14	PCI EXPRESS	
CHECKED BY	DATE	EDGE CARD CONNECTOR	
HARVEY	2007/05/14	(LEAD FREE VERSION)	
APPROVED BY	DATE	MOLEX INCORPORATED	
JENNY CHEN	2007/05/14		
MATERIAL NO.	DOCUMENT NO.	SHEET NO.	
SEE SHEET 4	SD-87715-901	1 OF 4	

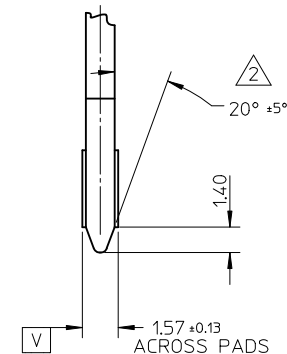
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION



PRIMARY (COMPONENT) SIDE



SECONDARY (SOLDER) SIDE



- 1 NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1 AND "C".
- 2 CHAMFER EDGES MUST BE FREE OF CUTTING BURRS.
- 3 TOLERANCE: .XX±.13

CONNECTOR LINK WIDTH	# POS REF	N	DIM 'B'	'C' 1
X1	36	6	8.15	B17
X16	164	70	72.15	B17, B31 B48,B81

SEE SHEET 1 EC NO: SH2011-0358 DRWN: F YANG05 CHKD: APPR: RZHANG REV	DESCRIPTION 2011/06/07	QUALITY SYMBOLS F_A=0 F_C=0 F_P=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY DAVID HU	DATE 2007/05/14	TITLE PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION)				
						CHECKED BY HARVEY	DATE 2007/05/14					
			4 PLACES	± ---	± ---			MOLEX INCORPORATED				
			3 PLACES	± ---	± ---							
			2 PLACES	± 0.25	± ---			MOLEX INCORPORATED				
			1 PLACE	± 0.25	± ---							
			ANGULAR ± 3 °		APPROVED BY JENNY CHEN		DATE 2007/05/14	 MOLEX INCORPORATED		DOCUMENT NO.		SHEET NO. 3 OF 4
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		SEE SHEET 1		SD-87715-901			
		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH	PEG 1	PEG 2	DESCRIPTION
87715-9000	36	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54	WITH	WITH	TOOLED
87715-9002					15 MICROINCH				
87715-9005					15 MICROINCH	3.00			
87715-9006					30 MICROINCH	2.54			
87715-9009					30 MICROINCH	3.00			



MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH	PEG 1	PEG 2	DESCRIPTION
87715-9300	164	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54	WITH	WITH	TOOLED
87715-9302					15 MICROINCH				
87715-9303					GOLD FLASH	3.00			
87715-9305					15 MICROINCH				
87715-9306					30 MICROINCH	2.54			
87715-9309					30 MICROINCH	3.00			

SEE SHEET 1

EC NO: SH2011-0358

DRWN:FYANG05

CH'KD:

APPR:RZHANG

2011/06/02

2011/06/07

QUALITY SYMBOLS

$F_A=0$

$F_C=0$

$F_P=0$

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	$\pm$ ---	$\pm$ ---
3 PLACES	$\pm$ ---	$\pm$ ---
2 PLACES	$\pm$ 0.25	$\pm$ ---
1 PLACE	$\pm$ 0.25	$\pm$ ---

ANGULAR $\pm$ 3 °

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE

MM ONLY

DRAWN BY	DATE
DAVID HU	2007/05/14
CHECKED BY	DATE
HARVEY	2007/05/14
APPROVED BY	DATE
JENNY CHEN	2007/05/14

MATERIAL NO.

SEE SHEET 1

SCALE

DESIGN UNITS

METRIC

THIRD ANGLE PROJECTION

TITLE

PCI EXPRESS
EDGE CARD CONNECTOR
(LEAD FREE VERSION)

MOLEX INCORPORATED

DOCUMENT NO.

SD-87715-901

SHEET NO.

4 OF 4

SIZE

A3

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9